

Special Issue

Microfluidics in Biomedical Applications

Message from the Guest Editor

The rise of what we call microfluidics in biomedical applications is characterized by an influx into biomedicine of microfluidic methods. The microfluidics indeed offers a growing set of tools for handling small volumes of fluids that are relevant to numerous biomedical disciplines, ranging from diagnostics to therapeutics in personalized medicine. This Special Issue invites manuscripts (research papers, perspectives and review articles) related to the exciting wide field of microfluidic platforms for biomedical applications.

Guest Editor

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